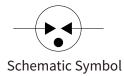


FEATURES

Surface Mounting Design 4.5*3.2*2.7mm	
---------------------------------------	--

- High Current Handling Capability 3000A @ 8/20 μs
- Low Capacitance and Insertion Loss
- Quick Response and Long Service Life
- Moisture sensitivity level:Level 1





APPLICATION INFORMATION

Communication equipment.

- Repeaters, Modems
- | Telephone Interface,Line cards.

Data communication equipment.

AGENCY APPROVALS

lcon	Solderability		
RoHS	Compliance with 2011/65/EU		
HF	Compliance with IEC61249-2-21:2003		
Ø	Mean lead free		

PRODUCT CHARACTERISTICS

Lead Material	Body Material	Terminal Finish
Copper or Fe-Ni alloy	Ceramics	100% Matte-Tin Plated



ELECTRICAL PARAMETER

Parameter	Condition	Rating	Unit
DC Blocking Voltage 1)	100V/s	480-720	V
Impulse Spark over Voltage	At 1kV/μs	for 99 % of measured values \leqslant 1300	V
Impulse Spark-over Voltage	At 1kV/μs	Typical values of distribution ≤ 1200	V
Impulse Discharge Current 2)	8/20µs	3000	А
Insulation Resistance	DC=50V	≥1	GΩ
Capacitance at 1MHz	V _{DC} =0.5V	≤ 1.0	pF
Operating And Storage Temperature		-40-125	°C

1) In ionized mode

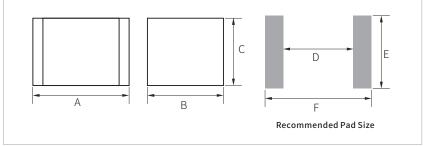
2) Terms and waveforms in accordance with ITU-T Rec. K. 12; IEC 61643-311

ENVIRONMENTAL RELIABILITY CHARACTERISTICS

Testing items	Technical standards
High Temperature Storage Test Temperature: 85°C ; Time:2H	
Low Temperature Storage Test	Temperature: -40°C ; Time:2H
Vibration Frequency: 10-500Hz ; Amplitude: 0.15mm ; Time: 45min	
Resistance of soldering heat	Temperature: 260±5°C; Time of dip soldering:10s, 1time

NOTE: Up-screen program can be specified by customer's request via contacting Semiware service

DIMENSIONS AND RECOMMENDED SOLDERING PAD



Ref.	mm
А	4.5±0.3mm
В	3.2±0.3mm
С	2.7±0.3mm
D	2.8mm
Е	4.0mm
F	5.2mm



SOLDERABILITY TEST

Solderability		
Solder Pot Temperature	Solder Dwell Time	
245°C ± 5°C	4-6 seconds	

REFLOW PROFILE

	Reflow Condition	Lead-free assembly
	Temperature Min	150°C
Pre Heat	Temperature Max	200°C
	Time(min to max)	60 – 180 secs
Average ramp up rate (Liquidus)Temp (T,) to peak		3°C/second max
	$T_{s(max)}$ to T_{L} - Ramp-up Rate	5 0/30001011100
	Temperature (T _L) (Liquidus)	217°C
Reflow	Time(min to max)(t _s)	60 – 150 seconds
Peak Terr	nperature (T _P)	260 °C
Time with	nin 5°C of actual peak Temperature (tp)	20-40 seconds
Ramp-do	own Rate	6°C/second max
Time 25°	C to peak Temperature (T _P)	8 minutes max.
Do not ex	ceed	260°C

ORDERING INFORMATION

Part Number	Size	QTY/Reel	Reel Size
SG4532B600H	4.5*3.2*2.7mm	2500PCS	13"



Headquarters

No.3387 Shendu Road Pujiang I&E Park Minhang Shanghai China 201000

Hotline

400-021-5756

Web

Https://www.semiware.com

Sales Center

Tel: 86-21-3463-7458 Email: sales18@semiware.com

Customer Service

Tel: 86-21-5484-1001 Email: sales17@semiware.com

Technical Support

Tel: 86-21-3463-7654 Email: fae01@semiware.com

Complaint & Suggestions

Tel: 86-21-3463-7172 Ext: 8868 Email: cs03@semiware.com

By QR Code





Website

Wechat

To find your local partner within Semiware's global website: www.semiware.com © 2022 Semiware Semiconductor Inc.

The content of this document has been carefully checked and understood. However, neither Semiware nor its subsidiaries assume any liability whatsoever for any errors or inaccuracies of this document and the consequences thereof. Published specifications are subject to change without notice. Product suitability for any area of application must ultimately be determined by the customer. In all cases, products must never be operated outside their published specifications. Semiware does not guarantee the availability of all published products. This disclaimer shall be governed by substantive Chinese law and resulting disputes shall be settled by the courts at the place of business of Semiware. Latest publications and a complete disclaimer can be downloaded from the Semiware website. All trademarks recognized.